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<u>Silicon Carbide (SiC)</u> <u>MOSFET</u> – EliteSiC, 13 mohm, 1200 V, M3S, TO-247-4L

NTH4L013N120M3S

Features

- Typ. $R_{DS(on)} = 13 \text{ m}\Omega @ V_{GS} = 18 \text{ V}$
- Ultra Low Gate Charge ($Q_{G(tot)} = 254 \text{ nC}$)
- High Speed Switching with Low Capacitance ($C_{oss} = 262 \text{ pF}$)
- 100% Avalanche Tested
- This Device is Halide Free and RoHS Compliant with exemption 7a, Pb–Free 2LI (on second level interconnection)

Typical Applications

- Solar Inverters
- Electric Vehicle Charging Stations
- UPS (Uninterruptible Power Supplies)
- Energy Storage Systems
- SMPS (Switch Mode Power Supplies)

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-to-Source Voltage	V _{DSS}	1200	V
Gate-to-Source Voltage	V _{GS}	-10/+22	V
Recommended Operation Values of Gate-to-Source Voltage, $T_C < 175^{\circ}C$	V _{GSop}	-5/+18	V
Continuous Drain Current – Steady State (Notes 1, 3) $T_C = 25^{\circ}C$ $T_C = 100^{\circ}C$	Ι _D	151 107	A
Power Dissipation – Steady State (Note 1) $T_C = 25^{\circ}C$ $T_C = 100^{\circ}C$	P _D	682 340	W
Pulsed Drain Current (Note 2), $T_C = 25^{\circ}C$	I _{DM}	505	А
Operating Junction and Storage Temperature Range	T _J , T _{stg}	–55 to +175	°C
Source Current (Body Diode), $T_C = 25^{\circ}C$, $V_{GS} = -3 V$	I _S	151	A
Single Pulse Drain-to-Source Avalanche Energy (Note 4)	E _{AS}	800	mJ
Maximum Lead Temperature for Soldering (1/25" from case for 10 s)	ΤL	270	°C

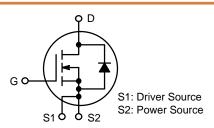
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Repetitive rating, limited by max junction temperature.

3. The maximum current rating is based on typical $R_{DS(on)}$ performance. 4. E_{AS} of 800 mJ is based on starting $T_J = 25^{\circ}$ C; L = 1 mH, $I_{AS} = 40$ A,

 $V_{DD}^{(1)} = 100 \text{ V}, \text{ V}_{GS} = 18 \text{ V}.$

V _{(BR)DSS}	R _{DS(ON)} TYP	I _D MAX
1200 V	13 mΩ @ 18 V	151 A



N-CHANNEL MOSFET



MARKING DIAGRAM

H4L013 120M3S AYWWZZ H4L013120M3S = Specific Device Code A = Assembly Location Y = Year WW = Work Week ZZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping
NTH4L013N120M3S	TO247-4L	30 Units / Tube

THERMAL CHARACTERISTICS

Parameter	Symbol	Тур	Max	Unit
Junction-to-Case - Steady State (Note 1)	$R_{ ext{ heta}JC}$	0.17	0.22	°C/W
Junction-to-Ambient - Steady State (Note 1)	$R_{ hetaJA}$	-	40	

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

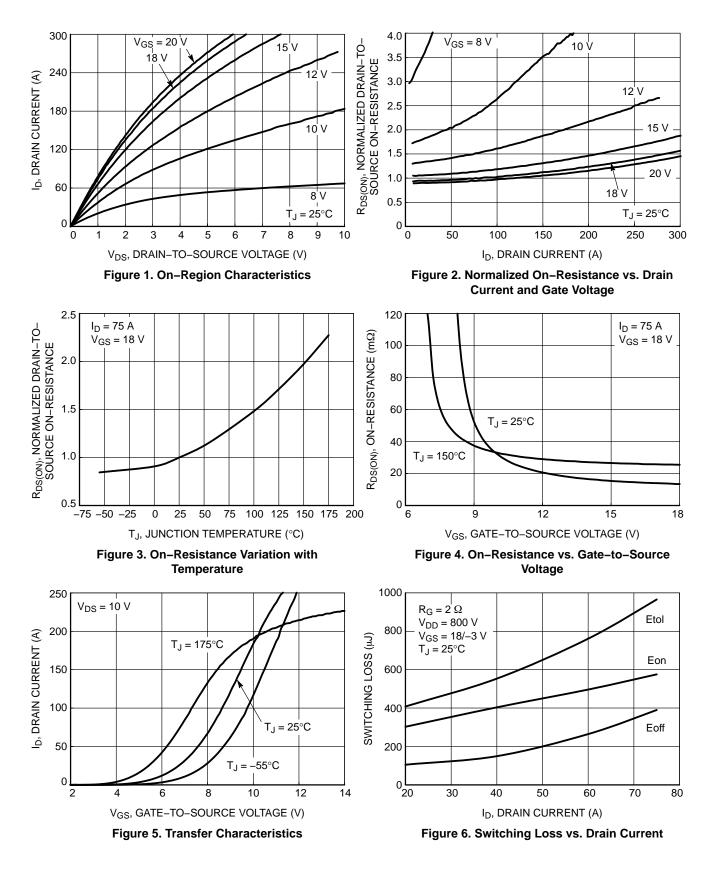
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF-STATE CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 V, I_{D} = 1 mA$		1200	-	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J	$I_D = 1 \text{ mA}$, referenced to 25°C (Note 6)		-	0.3	-	V/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 1200 V	T _J = 25°C	-	-	100	μΑ
Gate-to-Source Leakage Current	I _{GSS}	$V_{GS} = +22/-10 \text{ V}, \text{ V}_{DS}$	= 0 V	-	-	±1	μΑ
ON-STATE CHARACTERISTICS (Note 2)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 37 \text{ mA}$		2.04	2.8	4.4	V
Recommended Gate Voltage	V _{GOP}			-5	-	+18	V
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 18 V, I _D = 75 A, 7	Г _Ј = 25°С	-	13	20	mΩ
		V _{GS} = 18 V, I _D = 75 A, T _J = 175°C (Note 6)		-	29	-	
Forward Transconductance	9 _{FS}	V _{DS} = 10 V, I _D = 75 A (N	Note 6)	-	57	-	S
CHARGES, CAPACITANCES & GATE RES	ISTANCE						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 800 V (Note 6)		-	5813	-	pF
Output Capacitance	C _{OSS}			-	262	-	1
Reverse Transfer Capacitance	C _{RSS}			-	21	-	
Total Gate Charge	Q _{G(TOT)}	V _{GS} = -3/18 V, V _{DS} = 800 V, I _D = 75 A (Note 6) f = 1 MHz		-	254	-	nC
Threshold Gate Charge	Q _{G(TH)}			-	37	-	
Gate-to-Source Charge	Q _{GS}			-	46	-	
Gate-to-Drain Charge	Q _{GD}			-	61	-	
Gate-Resistance	R _G			-	1.4	-	Ω
SWITCHING CHARACTERISTICS	-			•			
Turn-On Delay Time	t _{d(ON)}	$V_{GS} = -3/18 \text{ V}, V_{DS} = 8$	00 V,	-	22	-	ns
Rise Time	t _r	$I_D = 75 \text{ A}, \text{ R}_G = 4.7 \Omega$ Inductive load (Notes 5,	, 6)	-	23	-	
Turn-Off Delay Time	t _{d(OFF)}			-	56	-	
Fall Time	t _f	1		_	10	-	
Turn–On Switching Loss	E _{ON}	-		-	563	-	μJ
Turn-Off Switching Loss	E _{OFF}			-	390	-	
Total Switching Loss	E _{tot}			-	953	-	
SOURCE-DRAIN DIODE CHARACTERIST	ics	•					
Continuous Source–Drain Diode Forward Current	I _{SD}	V_{GS} = -3 V, T_C = 25°C	(Note 6)	-	-	151	A
Pulsed Source–Drain Diode Forward Current (Note 2)	I _{SDM}			-	-	505	
Forward Diode Voltage	V _{SD}	$V_{GS} = -3 \text{ V}, \text{ I}_{SD} = 75 \text{ A}, \text{ T}_{J} = 25^{\circ}\text{C}$		_	4.7	_	V

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified) (continued)

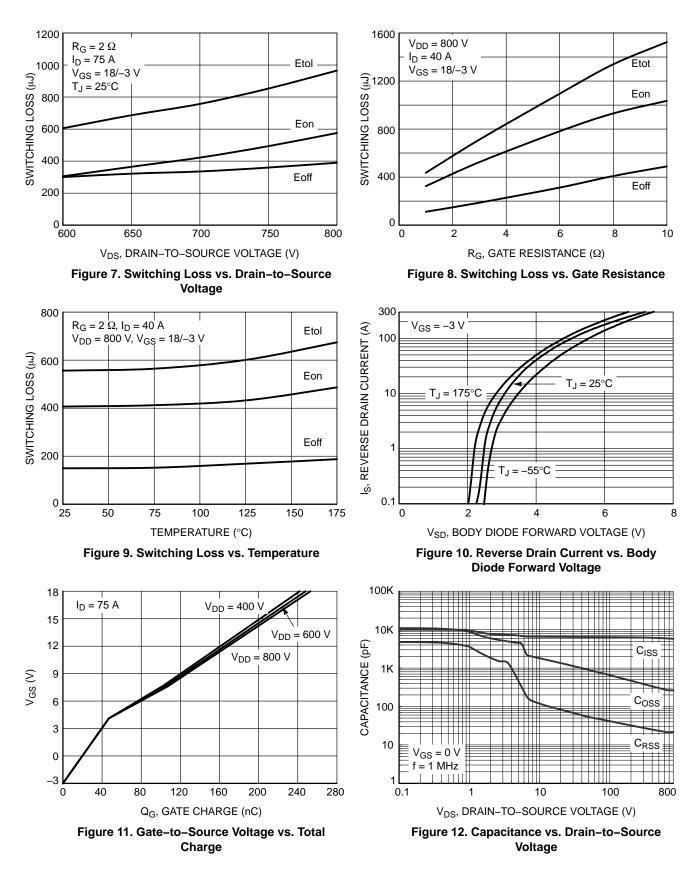
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit	
SOURCE-DRAIN DIODE CHARACTERISTICS							
Reverse Recovery Time	t _{RR}	V _{GS} = –3/18 V, I _{SD} = 75 A, dI _S /dt = 1000 A/μs, V _{DS} = 800 V	-	29	_	ns	
Reverse Recovery Charge	Q _{RR}	$dI_{S}/dt = 1000 \text{ A/}\mu\text{s}, \text{ V}_{DS} = 800 \text{ V}$ (Note 6)	-	252	-	nC	
Reverse Recovery Energy	E _{REC}		-	26	-	μJ	
Peak Reverse Recovery Current	I _{RRM}		-	18	-	А	
Charge Time	T _A		-	17	-	ns	
Discharge Time	Τ _Β]	-	12	-	ns	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
5. E_{ON}/E_{OFF} result is with body diode.
6. Defined by design, not subject to production test.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

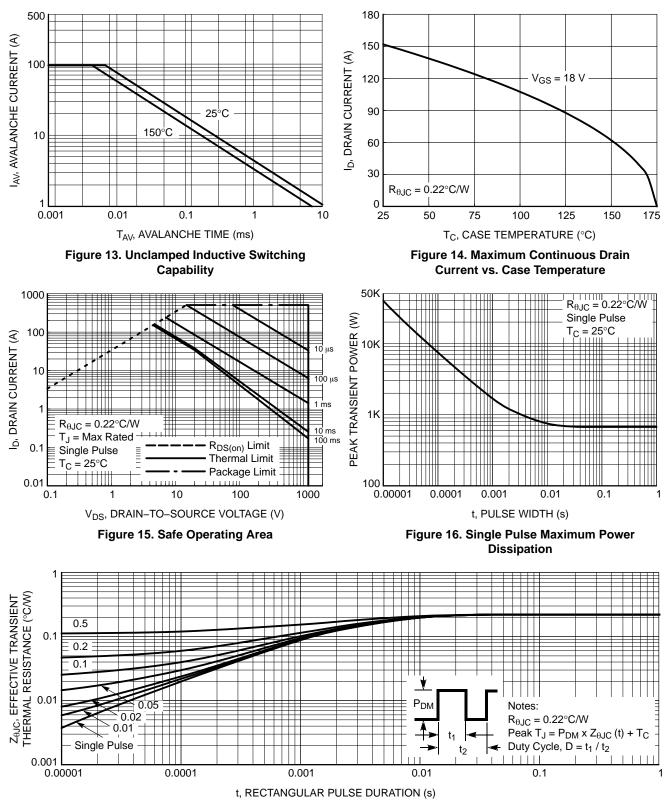
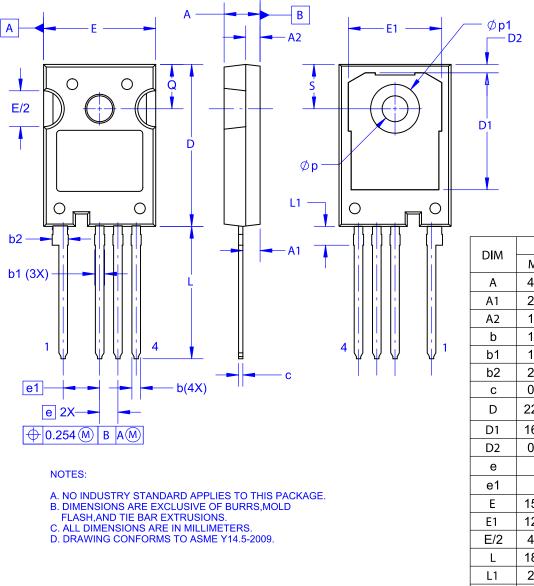


Figure 17. Junction-to-Case Transient Thermal Response



TO-247-4LD CASE 340CJ ISSUE A

DATE 16 SEP 2019



	MILLIMETERS				
DIM	MIN	NOM	MAX		
А	4.80	5.00	5.20		
A1	2.10	2.40	2.70		
A2	1.80	2.00	2.20		
b	1.07	1.20	1.33		
b1	1.20	1.40	1.60		
b2	2.02	2.22	2.42		
С	0.50	0.60	0.70		
D	22.34	22.54	22.74		
D1	16.00	16.25	16.50		
D2	0.97	1.17	1.37		
е	2.54 BSC				
e1	Ę	5.08 BSC	2		
Е	15.40	15.60	15.80		
E1	12.80	13.00	13.20		
E/2	4.80	5.00	5.20		
L	18.22	18.42	18.62		
L1	2.42	2.62	2.82		
р	3.40	3.60	3.80		
p1	6.60	6.80	7.00		
Q	5.97	6.17	6.37		
S	5.97	6.17	6.37		

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